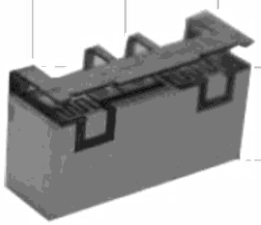
UPB260A - PRELIMINARY

2515-2675MHz UPB Series TDD Bandpass Filter

Features

- Low Loss with High Rejection
- Low ripple
- Universal footprint across family for all TDD bands



Part Dimensions: 10.2 × 7.9 × 4.0 mm • 1.2 g
Materials: Ag plated ceramic block with tin plated brass shield

Applications

- Wireless Infrastructure applications
- High-performance carrier-grade single-band TDD Pico-cell basestations for up to 1.0W at the antenna port.

Description

Surface mount ceramic bandpass filter supports a universal footprint across all TDD frequency bands enabling the use of a common system PCB. Superior rejection, insertion loss, reliability, as well as both peak and average power handling compared other bandpass filter technologies.

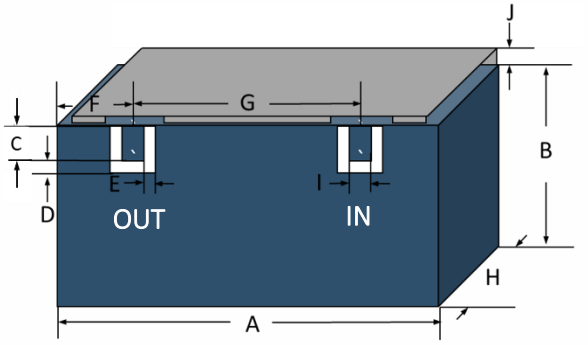
Electrical Specifications

Parameter	Frequency (MHz)	Typical at 25°C	Spec. at 25°C	Spec. over -40°C to +85°C
Nominal Impedance	-	50 ohms	-	-
Average Input Power	-	-	-	2.0 Watt max
Peak Input Power	-	-	-	20 Watt max
Input-Output Response				
Passband Insertion Loss (160 MHz avg)	2515-2675	1.0 dB	1.2 dB max	1.3 dB max
Passband Ripple	2515-2675	0.3 dB	0.5 dB max	0.5 dB max
Passband Return Loss	2515-2675	14 dB	12 dB min	12 dB min
Attenuation:	1-2200	40 dB	35 dB min	35 dB min
	2201-2300	32 dB	30 dB min	30 dB min
	2900-2999	32 dB	30 dB min	30 dB min
	3000-4400	40 dB	35 dB min	35 dB min

Note: CTS tests each unit to the critical specifications above. Subsequent audits may deviate due to repeatability among different test systems which shall not exceed these allowances.

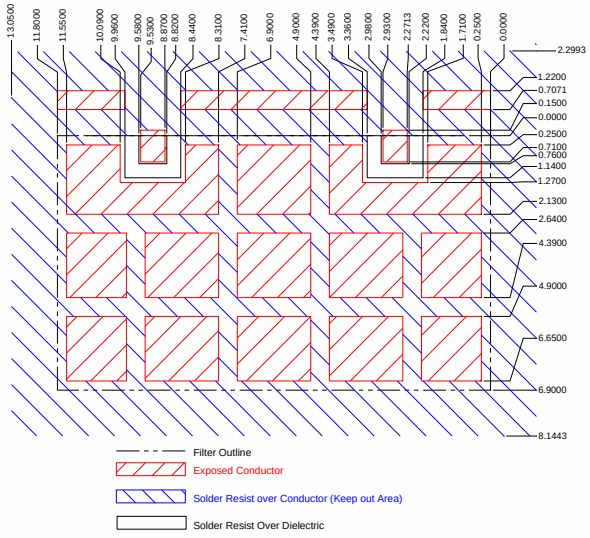
Specification Allowance	
Insertion Loss	0.1 dB
Return Loss	1.0 dB
Attenuation	1.0 dB

Mechanical Drawing



Dim.	Nominal (mm)	Tolerance (±mm or Max)
A	10.20	0.13
B	6.50	0.30
C	0.76	0.13
D	0.38	0.13
E	0.38	0.13
F	1.80	0.13
G	6.60	0.13
H	4.10	max
I	0.76	0.13
J	0.95	0.20

PCB Layout



IMPORTANT: Please assure >=30mils (0.75mm) thickness of dielectric beneath the I/O Pads and the surrounding clearance zone down to the required ground plane.

Please assure sufficient ground vias between the top metal ground plane and the primary ground plane.

Recommended solder: 6 mils of SAC305 with reflow including 120s of soak at 217°C, and up to 30 sec peak at 241°C.

NOTE: A width of 9.50mm is necessary to support frequencies as low as 1885MHz for Band 39. If only higher frequency TDD bands are supported, then this smaller space can be allocated on the layout.

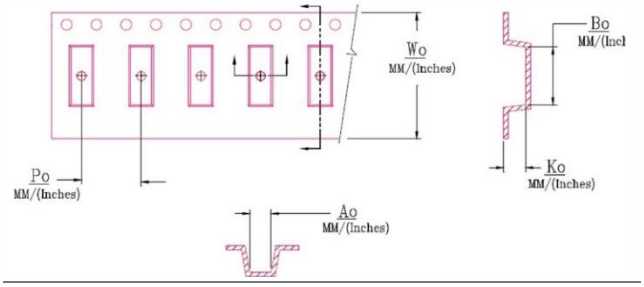
Packaging and Marking

Dimension	Units	Spec.
Reel Diameter	mm	330
Reel Weight	kg	5.5
Reel Quantity	ea.	500

Product Marking

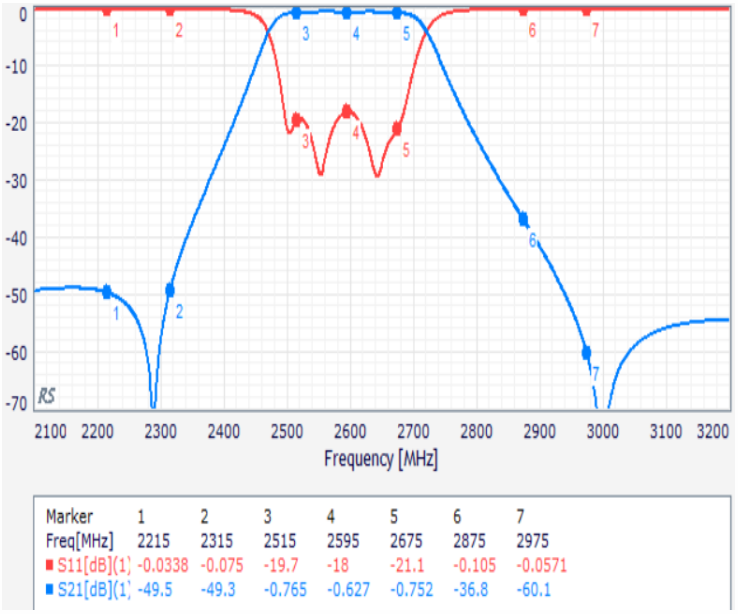
CTS
260
YWW

Customer Feed Direction → → →



Wo	Ao	Bo	Ko	Po
0.945 in 24.0 mm	0.319 in 8.10 mm	0.406 in 10.30 mm	0.165 in 4.2 mm	0.472 in 12.0 mm

Electrical Response



Marker	1	2	3	4	5	6	7
Freq[MHz]	2215	2315	2515	2595	2675	2875	2975
S11[dB](1)	-0.0338	-0.075	-19.7	-18	-21.1	-0.105	-0.0571
S21[dB](1)	-49.5	-49.3	-0.765	-0.627	-0.752	-36.8	-60.1